1. General description

The 74AXP1G10 is a single 3-input NAND gate.

Schmitt-trigger action at all inputs makes the circuit tolerant of slower input rise and fall times.

This device ensures very low static and dynamic power consumption across the entire V_{CC} range from 0.7 V to 2.75 V. It is fully specified for partial power down applications using I_{OFF} . The I_{OFF} circuitry disables the output, preventing the potentially damaging backflow current through the device when it is powered down.

2. Features and benefits

- Wide supply voltage range from 0.7 V to 2.75 V
- Low input capacitance; C_I = 0.5 pF (typical)
- Low output capacitance; C_O = 1.0 pF (typical)
- Low dynamic power consumption; C_{PD} = 2.5 pF at V_{CC} = 1.2 V (typical)
- Low static power consumption; I_{CC} = 0.6 μA (85 °C maximum)
- High noise immunity
- Complies with JEDEC standard:
 - JESD8-12A.01 (1.1 V to 1.3 V)
 - JESD8-11A.01 (1.4 V to 1.6 V)
 - ◆ JESD8-7A (1.65 V to 1.95 V)
 - ◆ JESD8-5A.01 (2.3 V to 2.7 V)
- ESD protection:
 - HBM ANSI/ESDA/JEDEC JS-001 Class 2 exceeds 2 kV
 - CDM JESD22-C101E exceeds 1000 V
- Latch-up performance exceeds 100 mA per JESD 78 Class II
- Inputs accept voltages up to 2.75 V
- Low noise overshoot and undershoot < 10 % of V_{CC}
- I_{OFF} circuitry provides partial Power-down mode operation
- Multiple package options
- Specified from -40 °C to +85 °C

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3. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74AXP1G10GM	–40 °C to +85 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body $1 \times 1.45 \times 0.5$ mm	SOT886
74AXP1G10GN	–40 °C to +85 °C	XSON6	extremely thin small outline package; no leads; 6 terminals; body $0.9 \times 1.0 \times 0.35$ mm	SOT1115
74AXP1G10GS	–40 °C to +85 °C	XSON6	extremely thin small outline package; no leads; 6 terminals; body $1.0 \times 1.0 \times 0.35$ mm	SOT1202

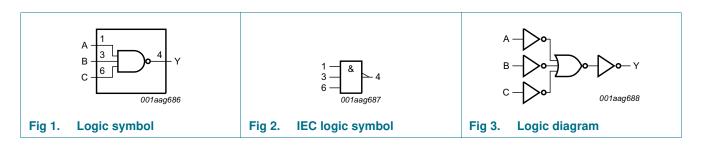
4. Marking

Table 2.	Marking

Type number	Marking code ^[1]
74AXP1G10GM	RM
74AXP1G10GN	RM
74AXP1G10GS	RM

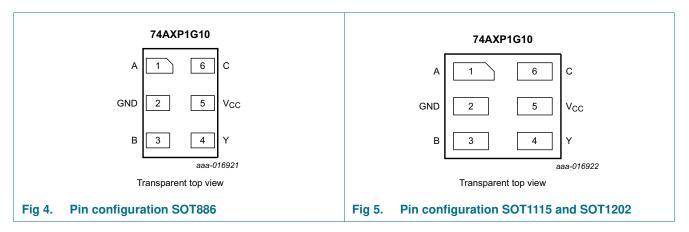
[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

5. Functional diagram



6. Pinning information

6.1 Pinning



6.2 Pin description

Table 3. Pin description		
Symbol	Pin	Description
A	1	data input
GND	2	ground (0 V)
В	3	data input
Y	4	data output
V _{CC}	5	supply voltage
С	6	data input

7. Functional description

Table 4. Function table^[1]

Input	Output		
Α	В	C	Y
Н	Н	Н	L
L	Х	Х	Н
Х	L	Х	Н
X	Х	L	Н

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care.

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CC}	supply voltage			-0.5	+3.3	V
I _{IK}	input clamping current	V ₁ < 0 V		-50	-	mA
VI	input voltage		[1]	-0.5	+3.3	V
I _{OK}	output clamping current	V _O < 0 V		-50	-	mA
Vo	output voltage		[1]	-0.5	+3.3	V
lo	output current	$V_{O} = 0 V$ to V_{CC}		-	±20	mA
I _{CC}	supply current			-	50	mA
I _{GND}	ground current			-50	-	mA
T _{stg}	storage temperature			-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \ ^{\circ}C \ to \ +85 \ ^{\circ}C$		-	250	mW

[1] The minimum input and output voltage ratings may be exceeded if the input and output current ratings are observed.

9. Recommended operating conditions

Table 6. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		0.7	2.75	V
VI	input voltage		0	2.75	V
Vo	output voltage	Active mode	0	V _{CC}	V
		Power-down mode; $V_{CC} = 0 V$	0	2.75	V
T _{amb}	ambient temperature		-40	+85	°C
$\Delta t / \Delta V$	input transition rise and fall rate	$V_{CC} = 0.7 \text{ V} \text{ to } 2.75 \text{ V}$	0	200	ns/V

10. Static characteristics

Table 7. Static characteristics

At recommended operating conditions, unless otherwise specified; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions			$T_{amb} = -40$	°C to +85 °C				
				Min	Typ 25 °C	Max 25 °C	Max 85 °C			
V _{IH}	HIGH-level input	V _{CC} = 0.75 V to 0.85 V		$0.75 \times V_{CC}$	-	-	-	V		
	voltage	V _{CC} = 1.1 V to 1.95 V		$0.65 imes V_{CC}$	-	-	-	V		
		$V_{CC} = 2.3 \text{ V} \text{ to } 2.7 \text{ V}$		1.6	-	-	-	V		
V _{IL}	LOW-level input	V _{CC} = 0.75 V to 0.85 V		-	-	$0.25 \times V_{CC}$	$0.25 \times V_{CC}$	V		
	voltage	V _{CC} = 1.1 V to 1.95 V		-	-	$0.35 \times V_{CC}$	$0.35 \times V_{CC}$	V		
		$V_{CC} = 2.3 \text{ V} \text{ to } 2.7 \text{ V}$		-	-	0.7	0.7	V		
V _{OH}	HIGH-level	$I_{O} = -20 \ \mu A; V_{CC} = 0.7 \ V$		-	0.69	-	-	V		
	output voltage	$I_{O} = -100 \ \mu A; V_{CC} = 0.75 \ V$		0.65	-	-	-	V		
		$I_{O} = -2 \text{ mA}; V_{CC} = 1.1 \text{ V}$		0.825	-	-	-	V		
		$I_{O} = -3 \text{ mA}; V_{CC} = 1.4 \text{ V}$		1.05	-	-	-	V		
		$I_{O} = -4.5 \text{ mA}; V_{CC} = 1.65 \text{ V}$		1.2	-	-	-	V		
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$		1.7	-	-	-	V		
V _{OL}	LOW-level	$I_{O} = 20 \ \mu A; \ V_{CC} = 0.7 \ V$		-	0.01	-	-	V		
	output voltage	$I_{O} = 100 \ \mu A; V_{CC} = 0.75 \ V$		-	-	0.1	0.1	V		
		I _O = 2 mA; V _{CC} = 1.1 V		-	-	0.275	0.275	V		
		$I_{O} = 3 \text{ mA}; V_{CC} = 1.4 \text{ V}$		-	-	0.35	0.35	V		
		I _O = 4.5 mA; V _{CC} = 1.65 V		-	-	0.45	0.45	V		
		$I_{O} = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$		-	-	0.7	0.7	V		
lı	input leakage current	$V_{I} = 0 V \text{ to } 2.75 V;$ $V_{CC} = 0 V \text{ to } 2.75 V$	[1]	-	0.001	±0.1	±0.5	μA		
I _{OFF}	power-off leakage current	V_{I} or $V_{O} = 0$ V to 2.75 V; $V_{CC} = 0$ V	[1]	-	0.01	±0.1	±0.5	μA		
ΔI_{OFF}	additional power-off leakage current		[1]	-	0.02	±0.1	±0.5	μA		
I _{CC}	supply current	$V_{I} = 0 V \text{ or } V_{CC}; I_{O} = 0 A$	<u>[1]</u>	-	0.01	0.3	0.6	μA		
ΔI_{CC}	additional supply current	$ \begin{array}{l} V_{I} = V_{CC} - 0.5 \; V; I_{O} = 0 \; A; \\ V_{CC} = 2.5 \; V \end{array} $		-	2	100	150	μA		

[1] Typical values are measured at V_{CC} = 1.2 V.

11. Dynamic characteristics

Table 8. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit, see Figure 12.

Symbol	Parameter	Conditions	T,	amb = 25 °	°C	$T_{amb} = -40$	°C to +85 °C	Unit
			Min	Typ[1]	Max	Min	Max	
t _{pd}	propagation	A, B, C to Y; see Figure 6						
	delay	V _{CC} = 0.75 V to 0.85 V	3	12	51	1	116	ns
		V _{CC} = 1.1 V to 1.3 V	1.7	4.5	8.4	1.6	8.7	ns
		V _{CC} = 1.4 V to 1.6 V	1.3	3.2	5.5	1.2	5.9	ns
		V _{CC} = 1.65 V to 1.95 V	1.1	2.6	4.5	1.0	4.8	ns
		V _{CC} = 2.3 V to 2.7 V	0.9	2.0	3.2	0.8	3.5	ns
t _t	transition time	V _{CC} = 2.7 V; see <u>Figure 6</u> [4]	-	-	-	1.0	-	ns
CI	input capacitance		-	0.5	-	-	-	pF
Co	output capacitance	$V_{O} = 0 V; V_{CC} = 0 V$	-	1.0	-	-	-	pF
C _{PD}	power dissipation	$f_i = 1 \text{ MHz}; V_i = 0 \text{ V to } V_{CC}$ [5]						
	capacitance	V _{CC} = 0.75 V to 0.85 V	-	2.4	-	-	-	pF
		V _{CC} = 1.1 V to 1.3 V	-	2.5	-	-	-	pF
		V _{CC} = 1.4 V to 1.6 V	-	2.5	-	-	-	pF
		V _{CC} = 1.65 V to 1.95 V	-	2.6	-	-	-	pF
		V _{CC} = 2.3 V to 2.7 V	-	2.8	-	-	-	pF

[1] All typical values are measured at nominal $V_{\mbox{CC}}.$

[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

[3] For additional propagation delay values at different load capacitances, see Figure 7 to Figure 11.

[4] t_t is the same as t_{THL} and t_{TLH} .

[5] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + C_L \times V_{CC}^2 \times f_o$ where:

 f_i = input frequency in MHz;

f_o = output frequency in MHz;

 C_L = output load capacitance in pF;

 V_{CC} = supply voltage in V;

N = number of inputs switching.

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12. Waveforms

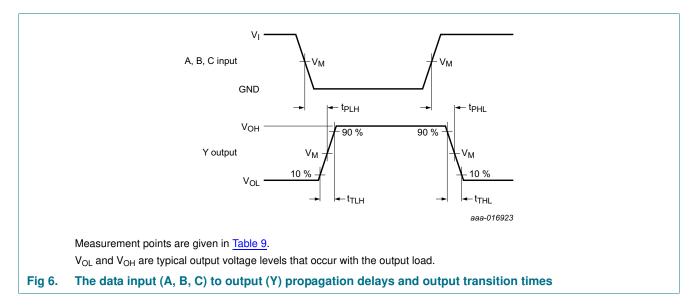
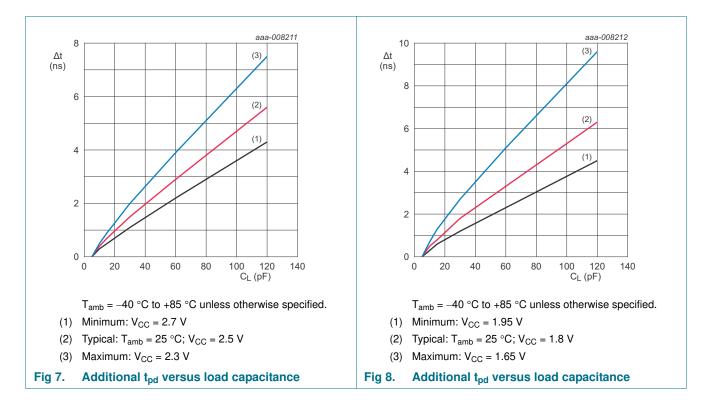


Table 9.Measurement points

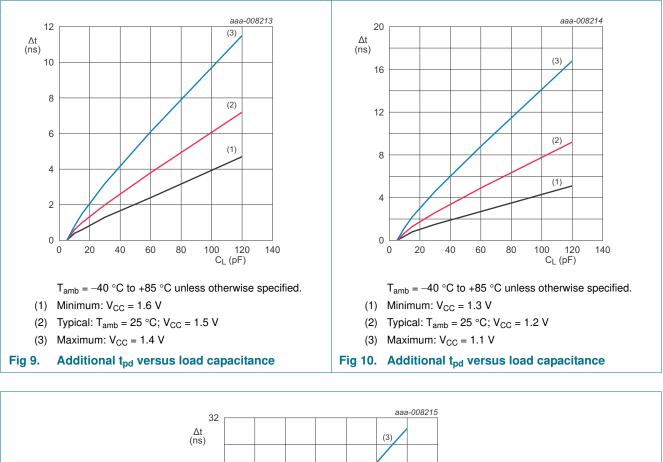
Supply voltage	Input	Output		
V _{CC}	V _M	VI	$t_r = t_f$	V _M
0.75 V to 2.7 V	$0.5\times V_{CC}$	V _{CC}	≤ 3.0 ns	$0.5 imes V_{CC}$

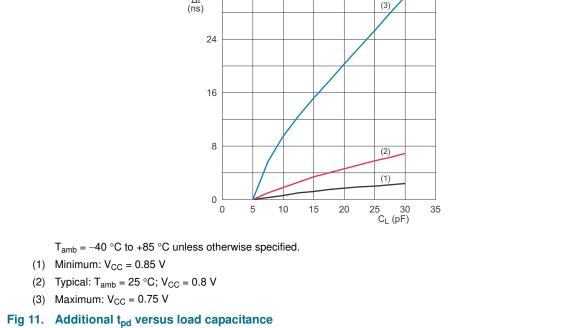


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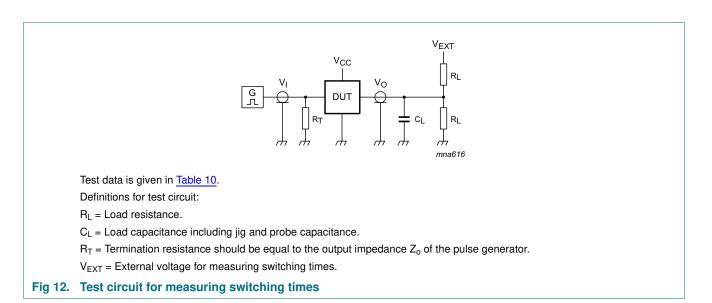


Table 10. Test data

Supply voltage	Load		V _{EXT}			
V _{cc}	CL	RL	t _{PLH} , t _{PHL} t _{PZH} , t _{PHZ} t _{PZL} , t _{PLZ}			
0.75 V to 2.7 V	5 pF	10 kΩ	0 V	0 V	$2 \times V_{CC}$	

13. Package outline

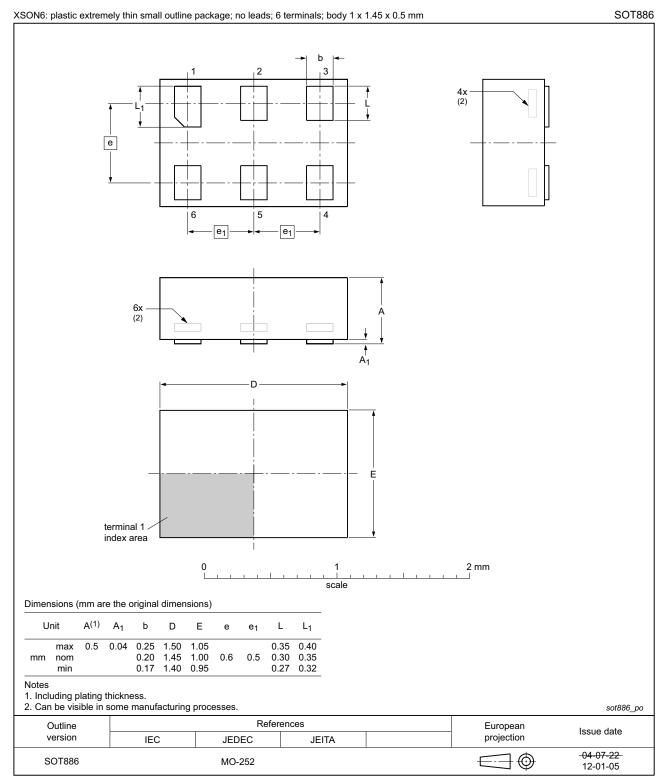
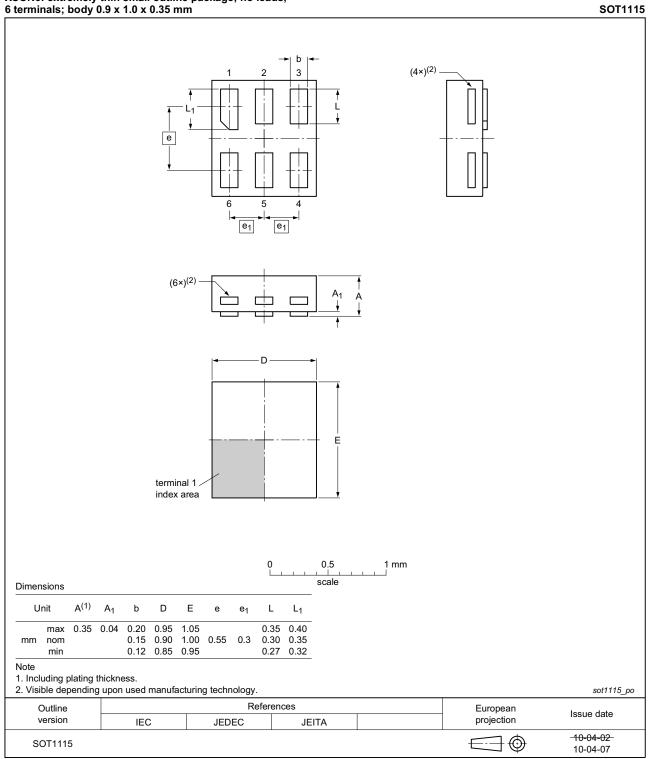


Fig 13. Package outline SOT886 (XSON6)

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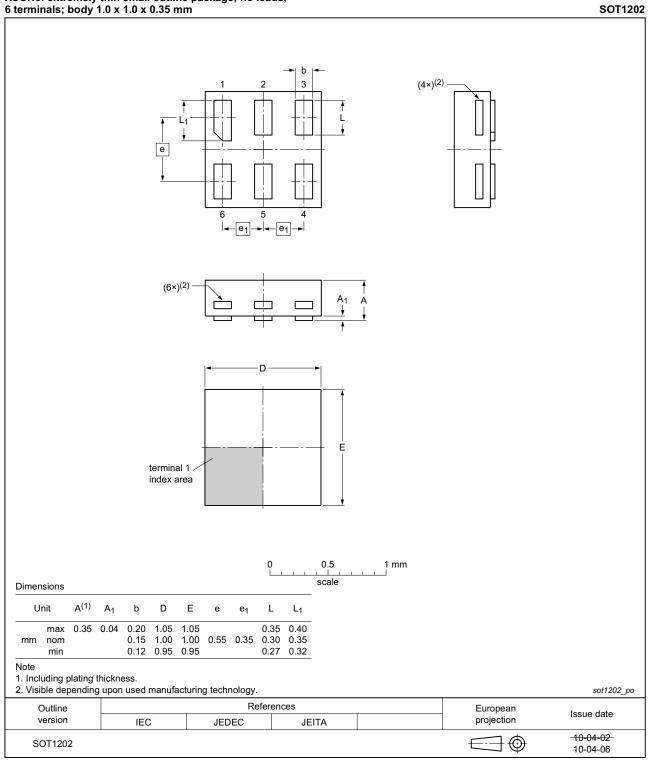


XSON6: extremely thin small outline package; no leads; 6 terminals; body 0.9 x 1.0 x 0.35 mm

Fig 14. Package outline SOT1115 (XSON6)

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XSON6: extremely thin small outline package; no leads; 6 terminals; body 1.0 x 1.0 x 0.35 mm

Fig 15. Package outline SOT1202 (XSON6)

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14. Abbreviations

Table 11. Abbreviations			
Acronym	Description		
CDM	Charged Device Model		
DUT	Device Under Test		
ESD	ElectroStatic Discharge		
НВМ	Human Body Model		

15. Revision history

Table 12. Revision history	Table 12.	Revision	history
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Document ID	Release date	Data sheet status	Change notice	Supersedes
74AXP1G10 v.1	20151020	Product data sheet	-	-

16. Legal information

16.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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